

Note:  $0.3 \sim 0.9 \text{m}\Omega$  without marking

Figure 1. Construction and Dimensions

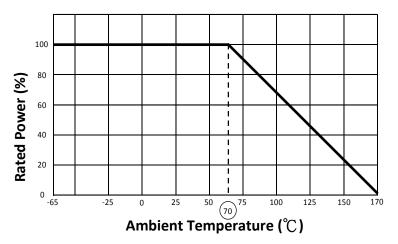
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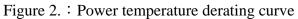
5. Specification

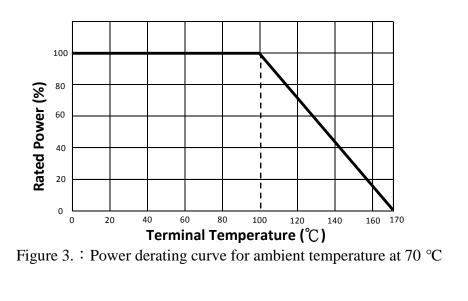
Specification						
Characteristics	Feature					
Power Rating*	5W					
Resistance Value	0.3 ~ 1 mΩ					
	0.3~0.4 mΩ	0.5~0.9 mΩ	1 mΩ			
Temperature Coefficient of Resistance	± 150 ppm/°C	± 100 ppm/°C	± 75 ppm/°C			
Operation Temperature Range	-65°C ~ +170°C					
Resistance Tolerance	$\pm 1\%$ (F), $\pm 2\%$ (G), $\pm 5\%$ (J)					
Insulation Resistance	Over 100MΩ					
Maximum Working Voltage (V)	$(P*R)^{1/2}$					

Note \* :

Power rating is based on continuous full load operation at rated ambient temperature of  $70^{\circ}$ C. For resistors operated at ambient temperature in excess of  $70^{\circ}$ C, the maximum load shall be derated in accordance with the following curve.







### 6. Characteristics

6-1 Electrical

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Item	Specification and Requirement	Test Method	
Temperature Coefficient (TCR)	As follow specification .	JIS-C-5201 +25℃/ +125℃	
Short Time Overload	$\Delta R: \pm (0.5\% + 0.0005\Omega)$ Without damage by flashover, spark, arcing, burning or breakdown	JIS-C-5201-1 4.13 2.5 x rated power for 5 seconds	
Insulation Resistance	Over 100 MΩ on Overcoat layer face up	JIS-C-5201-1 4.6 100V <sub>DC</sub> for 60 +10/-0 seconds	
Voltage Proof	$\Delta R: \pm (1\% + 0.0005\Omega)$ Without damage by flashover, spark, arcing, burning or breakdown	JIS-C-5201-1 4.7 400V <sub>AC</sub> (rms.) for 60 +10/ -0 seconds	
ESD	$\Delta R: \pm (1\% + 0.0005\Omega)$	AEC-Q200-002 Human body, 3KV	

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### 6-2 Mechanical

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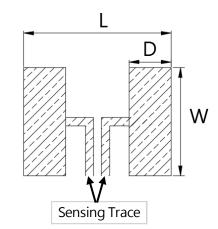
Item	Specification and Requirement	Test Method
Solderability	The surface of terminal immersed shall be minimum of 95% covered with a new coating of solder	JIS-C-5201-1 4.17 245 $\pm$ 5°C for 3 $\pm$ 0.5 seconds
Resistance to Solder Heat	$\Delta R: \pm (0.5\% + 0.0005\Omega)$ Without distinct deformation in appearance	JIS-C-5201-1 4.18 260±5℃ for 10± 1 seconds
Bending Test	$\Delta R: \pm (1.0\% + 0.0005\Omega)$ Without mechanical damage such as break	AEC-Q200-005 Bending value: 2 mm for 60 ± 1 seconds
Solvent Resistance	Without mechanical and distinct damage in appearance	MIL-STD-202 Method 215 Add Aqueous wash chemical OKEM Clean or equivalent. Do not use banned solvents
Vibration	$\Delta R: \pm (0.5\% + 0.0005\Omega)$ Without mechanical damage such as break	MIL-STD-202 Method 204 5g's for 20 minutes,12 cycles each of 3 orientations. Test from 10-2000Hz
Shock	$\Delta R: \pm (0.5\% + 0.0005\Omega)$ Without mechanical damage such as break	MIL-STD-202 Method 213 100g's peak value, 6ms, Half-sine waveform, 12.3ft/sec
Terminal Strength	No visible damage	JIS-C-5201-1 Force of 1.8Kg for 60 seconds.

#### 6-3 Endurance

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Item	Specification and Requirement	Test Method
Temperature Cycling	$\Delta R: \pm (0.5\% + 0.0005\Omega)$ Without distinct damage in appearance	JESD22 Method JA-104 1000 cycles, (-55°C~150°C) 30min maximum dwell time at each temperature.
Biased Humidity	$\Delta R: \pm (0.5\% + 0.0005\Omega)$	MIL-STD-202 Method 103 1000 hours, 85°C/85%R.H, applied for 10% rated power Measurement at 24±4 hours after test conclusion.
Damp heat, steady state	$\Delta R: \pm (0.5\% + 0.0005\Omega)$	IEC 60068-2 (40 ± 2) °C; (93 ± 3) % RH; 56 days
Load Life	$\Delta R: \pm (1.0\% + 0.0005\Omega)$ Without distinct damage in appearance	MIL-STD-202 Method 108 70°C, 100% rated power 1.5 hours ON, 0.5 hours Off For total 1000 hours Measurement at 24±4 hours after test conclusion.
High Temperature Store	$\Delta R: \pm (1.0\% + 0.0005\Omega)$ Without distinct damage in appearance	MIL-STD-202 Method 108 170°C for total 1,000 hours
Low temperature operation	$\Delta R: \pm (0.5\% + 0.0005\Omega)$ Without distinct damage in appearance	-65°C for total 24 hours

7. Recommended Solder Pad Dimensions



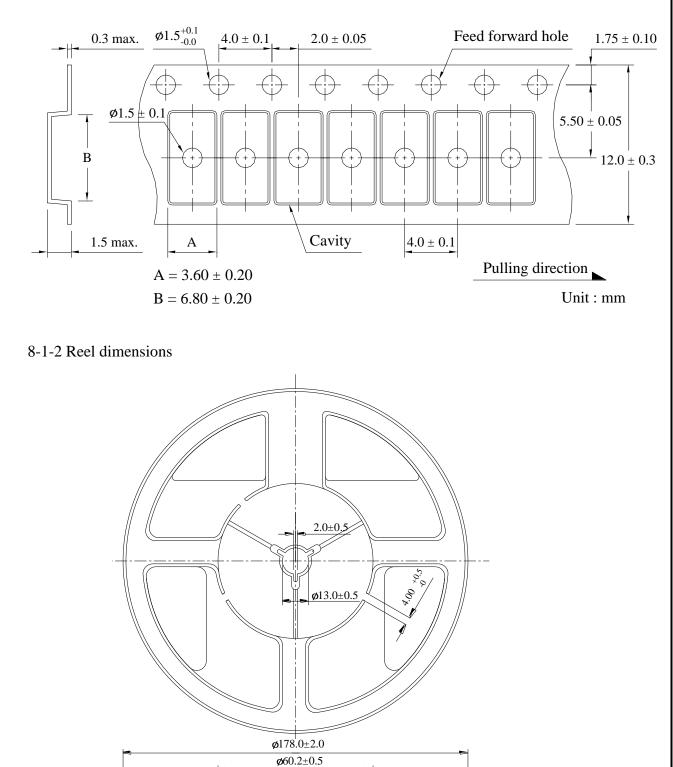
	Dimensions			
<b>Resistance Range</b>	W	L	D	t
	(mm)	(mm)	(mm)	( µ m)
0.3~ 1 mΩ	3.7	7.35	3.20	140

t: Copper foil minimum thickness of PCB

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- 8. Packaging
  - 8-1 Dimensions
    - 7-1-1 Tape packaging dimensions



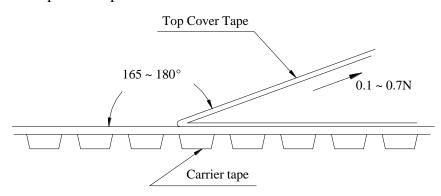
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13.2±1.5

 $16.0\pm0.2$ 

Unit : mm

8-2 Peel Strength of Top Cover TapeThe peel speed shall be about 300mm/min.The peel force of top cover tape shall between 0.1 to 0.7N



### 8-3 Number of Taping

2,000 pieces / reel

#### 8-4 Label marking

The following items shall be marked on the reel.

- (1) Type designation
- (2) Quantity
- (3) Manufacturing date code
- (4) Manufacturer's name
- (5) The country of origin

#### 9. Care note

- 9-1 Care note for storage
  - (1) Chip resistor shall be stored in a room where temperature and humidity must be controlled. (temperature 5 to 35°C, humidity 45 to 85% RH) However, a humidity keep it low, as it is possible.
  - (2) Chip resistor shall be stored as direct sunshine doesn't hit on it.
  - (3) Chip resistor shall be stored with no moisture, dust, a material that will make solderability inferior, and a harmful gas (Chloridation hydrogen, sulfurous acid gas, and sulfuration hydrogen)
- 9-2 Care note for operating and handling
  - (1) It is necessary to protect the edge and protection coat of resistors from mechanical stress.
  - (2) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
  - (3) Resistors shall be used with in rated range shown in specification. Especially, if voltage more than specified value will be loaded to resistor, there is a case it will make damage for machine because of temperature rise depending on generating of heat, and increase resistance value or breaks.
  - (4) In case that resistor is loaded a rated voltage, it is necessary to confirms temperature of a resistor and to reduce a load power according to load reduction curve, because a temperature rise of a resistor depends on influence of heat from mounting density and neighboring element.
  - (5) Observe Limiting element voltage and maximum overload voltage specified in each specification
  - (6) If there is possibility that a large voltage (pulse voltage, shock voltage) charge to resistor, it is necessary that operating condition shall be set up before use.